


- NOTES:
1. Dimensions are in inches [mm].
 2. Scale: 1.5x
 3. Recommended PCB hole diameter for pins: 0.050[1.27].
 4. 2oz. copper over 600V dielectric over aluminum substrate.
 5. Tin over nickel plated phosphor bronze pins.
 6. It is not recommended that mounting of the package rely on the pins for mechanical support.
 7. Use #4 or equivalent screws to mount to heat sink.
 8. Package Weight: 13 grams.

TOLERANCES - UNLESS OTHERWISE SPECIFIED				TITLE: MODULAR 23-PIN DIP 1.3" SPACING				MODEL: KL						
.XX = +/- .05" [1.27] .XXX = +/- .005" [1.27] ANG. = +/- 2 DEGREES				SUBJECT: PACKAGE OUTLINE										
ENGINEER: AA		DRAWN BY: EAS		DCA: 19051		SH. 1		OF 1		FILENAME: KL		REV: C	DATE: 11FEB19	